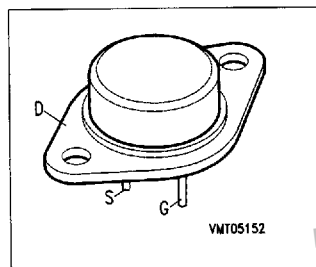


SIPMOS® Power Transistor**BUZ 15**

- N channel
- Enhancement mode
- Avalanche-rated



Type	V_{DS}	I_D	$R_{DS(on)}$	Package ¹⁾	Ordering Code
BUZ 15	50 V	45 A	0.03 Ω	TO-204 AE	C67078-S1001-A2

Maximum Ratings

Parameter	Symbol	Values	Unit
Continuous drain current, $T_C = 28\text{ }^\circ\text{C}$	I_D	45	A
Pulsed drain current, $T_C = 25\text{ }^\circ\text{C}$	$I_{D\text{ puls}}$	180	
Avalanche current, limited by $T_{J\text{ max}}$	I_{AR}	45	
Avalanche energy, periodic limited by $T_{J\text{ (max)}}$	E_{AR}	2.5	mJ
Avalanche energy, single pulse $I_D = 42\text{ A}$, $V_{DD} = 25\text{ V}$, $R_{GS} = 25\text{ } \Omega$ $L = 20.2\text{ } \mu\text{H}$, $T_J = 25\text{ }^\circ\text{C}$	E_{AS}	41	
Gate-source voltage	V_{GS}	± 20	V
Power dissipation, $T_C = 25\text{ }^\circ\text{C}$	P_{tot}	125	W
Operating and storage temperature range	T_J, T_{stg}	$- 55 \dots + 150$	$^\circ\text{C}$
Thermal resistance, chip-case	$R_{th\text{ JC}}$	≤ 1.0	K/W
DIN humidity category, DIN 40 040	–	C	–
IEC climatic category, DIN IEC 68-1	–	55/150/56	–

1) See chapter Package Outlines.

Electrical Characteristicsat $T_j = 25\text{ }^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Static characteristics

Drain-source breakdown voltage $V_{GS} = 0\text{ V}$, $I_D = 0.25\text{ mA}$	$V_{(BR)\text{ DSS}}$	50	–	–	V
Gate threshold voltage $V_{GS} = V_{DS}$, $I_D = 1\text{ mA}$	$V_{GS(th)}$	2.1	3.0	4.0	μA
Zero gate voltage drain current $V_{DS} = 50\text{ V}$, $V_{GS} = 0\text{ V}$ $T_j = 25\text{ }^\circ\text{C}$ $T_j = 125\text{ }^\circ\text{C}$	I_{DSS}	– –	0.1 10	1.0 100	
Gate-source leakage current $V_{GS} = 20\text{ V}$, $V_{DS} = 0\text{ V}$	I_{GSS}	–	10	100	nA
Drain-source on-resistance $V_{GS} = 10\text{ V}$, $I_D = 29\text{ A}$	$R_{DS(on)}$	–	0.025	0.030	Ω

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Dynamic characteristics

Forward transconductance $V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$, $I_D = 29\text{ A}$	g_{fs}	7.0	22.0	–	S
Input capacitance $V_{GS} = 0\text{ V}$, $V_{DS} = 25\text{ V}$, $f = 1\text{ MHz}$	C_{iss}	–	1800	2400	pF
Output capacitance $V_{GS} = 0\text{ V}$, $V_{DS} = 25\text{ V}$, $f = 1\text{ MHz}$	C_{oss}	–	800	1200	
Reverse transfer capacitance $V_{GS} = 0\text{ V}$, $V_{DS} = 25\text{ V}$, $f = 1\text{ MHz}$	C_{rss}	–	280	450	
Turn-on time t_{on} , ($t_{on} = t_{d(on)} + t_r$) $V_{DD} = 30\text{ V}$, $V_{GS} = 10\text{ V}$, $I_D = 3\text{ A}$, $R_{GS} = 50\text{ }\Omega$	$t_{d(on)}$	–	35	50	ns
	t_r	–	85	130	
Turn-off time t_{off} , ($t_{off} = t_{d(off)} + t_f$) $V_{DD} = 30\text{ V}$, $V_{GS} = 10\text{ V}$, $I_D = 3\text{ A}$, $R_{GS} = 50\text{ }\Omega$	$t_{d(off)}$	–	220	280	
	t_f	–	140	180	

Electrical Characteristics (cont'd)at $T_j = 25\text{ }^\circ\text{C}$, unless otherwise specified.

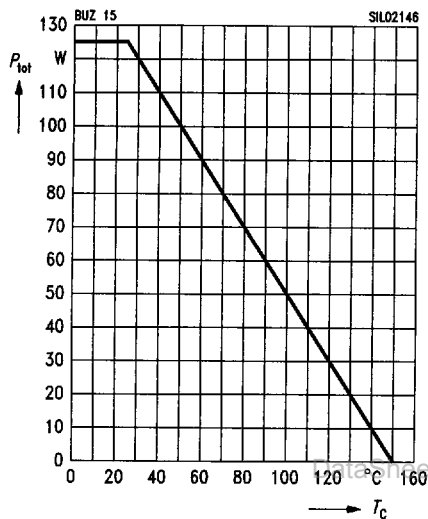
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Reverse diode					
Continuous reverse drain current $T_C = 25\text{ }^\circ\text{C}$	I_S	–	–	45	A
Pulsed reverse drain current $T_C = 25\text{ }^\circ\text{C}$	I_{SM}	–	–	180	A
Diode forward on-voltage $I_S = 90\text{ A}$, $V_{GS} = 0\text{ V}$	V_{SD}	–	1.8	2.2	V
Reverse recovery time $V_R = 30\text{ V}$, $I_F = I_S$, $di_F / dt = 100\text{ A}/\mu\text{s}$	t_{rr}	–	80	–	ns
Reverse recovery charge $V_R = 30\text{ V}$, $I_F = I_S$, $di_F / dt = 100\text{ A}/\mu\text{s}$	Q_{rr}	–	0.14	–	μC

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Characteristics at $T_I = 25\text{ }^\circ\text{C}$, unless otherwise specified.

Total power dissipation

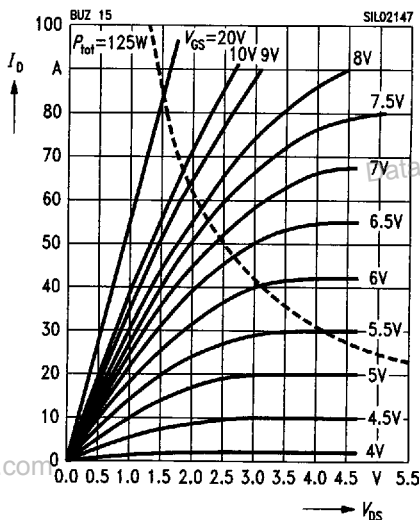
$P_{\text{tot}} = f(T_C)$



Typ. output characteristics

$I_D = f(V_{DS})$

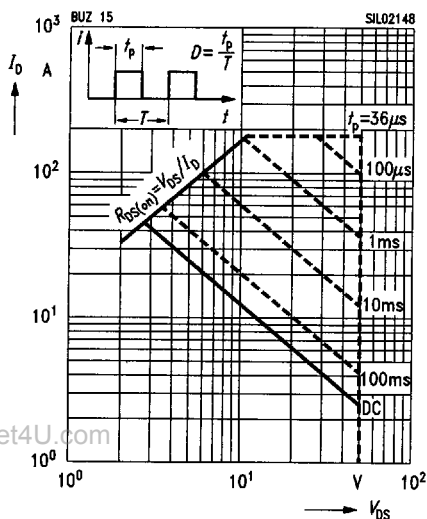
parameter: $t_p = 80\text{ }\mu\text{s}$



Safe operating area

$I_D = f(V_{DS})$

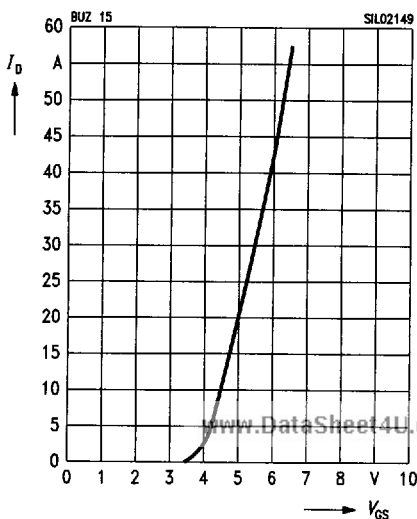
parameter: $D = 0.01$, $T_C = 25\text{ }^\circ\text{C}$



Typ. transfer characteristics

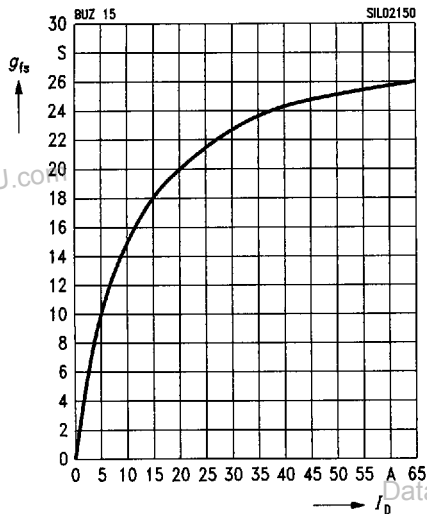
$I_D = f(V_{GS})$

parameter: $t_p = 80\text{ }\mu\text{s}$, $V_{DS} = 25\text{ V}$

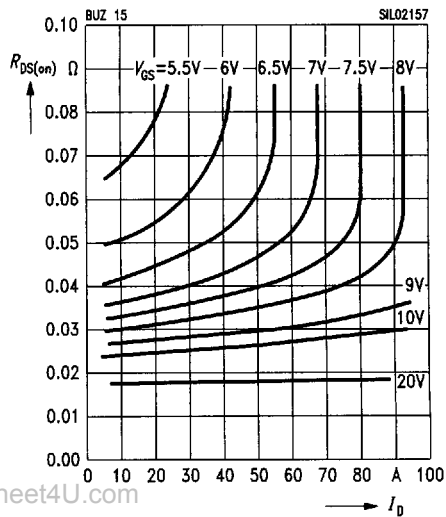


Typ. forward transconductance

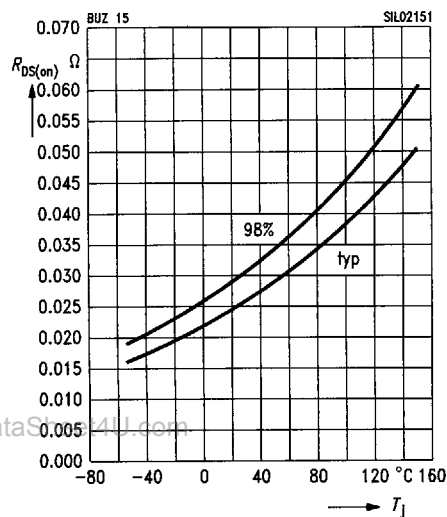
$$g_{fs} = f(I_D)$$

parameter: $t_p = 80 \mu\text{s}$ **Typ. drain-source on-resistance**

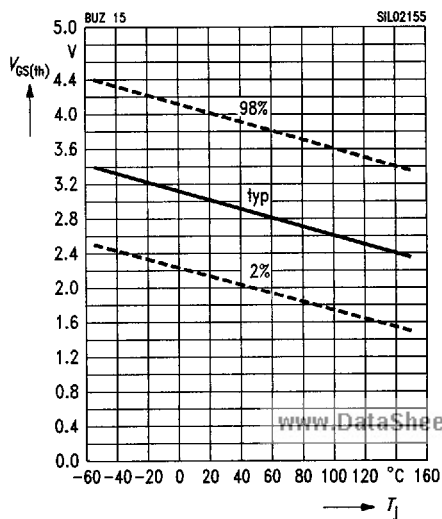
$$R_{DS(on)} = f(I_D)$$

parameter: V_{GS} **Drain-source on-resistance**

$$R_{DS(on)} = f(T_J)$$

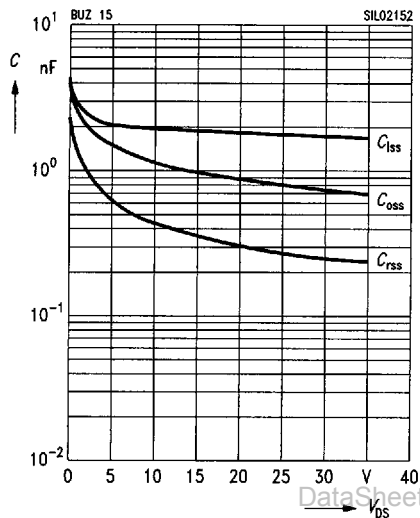
parameter: $I_D = 29 \text{ A}$, $V_{GS} = 10 \text{ V}$, (spread)**Gate threshold voltage**

$$V_{GS(th)} = f(T_J)$$

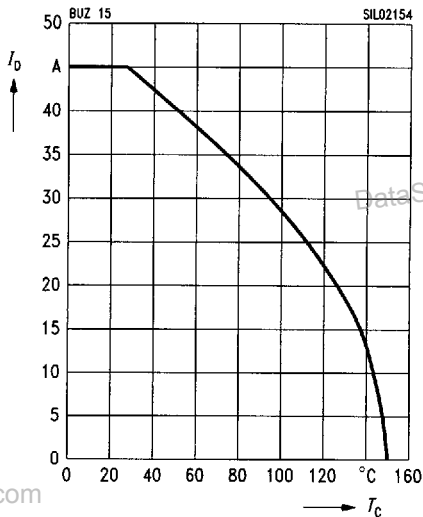
parameter: $V_{GS} = V_{DS}$, $I_D = 1 \text{ mA}$, (spread)

Typ. capacitances

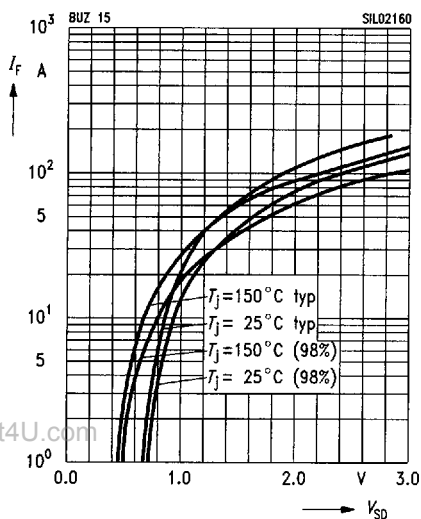
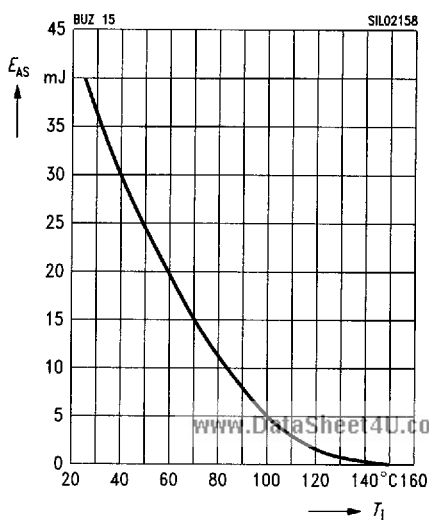
$$C = f(V_{DS})$$

parameter: $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$ **Drain current**

$$I_D = f(T_C)$$

parameter: $V_{GS} \geq 10 \text{ V}$ **Forward characteristics of reverse diode**

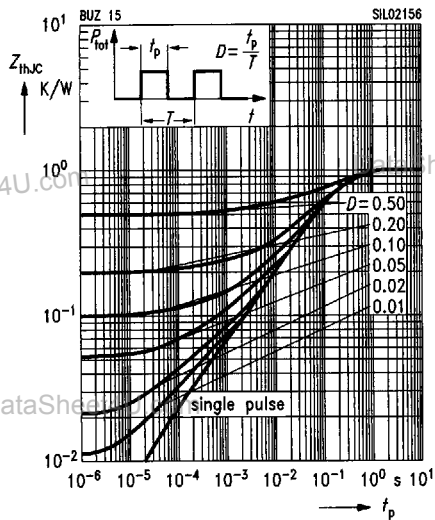
$$I_F = f(V_{SD})$$

parameter: T_j , $t_p = 80 \mu\text{s}$, (spread)**Avalanche energy $E_{AS} = f(T_j)$** parameter: $I_D = 45 \text{ A}$, $V_{DD} = 25 \text{ V}$ $R_{GS} = 25 \Omega$, $L = 20.2 \mu\text{H}$ 

Transient thermal impedance

$Z_{thJC} = f(t_p)$

parameter: $D = t_p / T$



Typ. gate charge

$V_{GS} = f(Q_{Gate})$

parameter: $I_{D\ pulse} = 63.0\ A$

